

#### DUAL SURFACE MOUNT SWITCHING DIODE

### **Features**

- Fast Switching Speed
- Small Surface Mount Package
- For General Purpose Switching Applications
- Lead Free/RoHS Compliant (Note 1)
- Qualified to AEC-Q101 Standards for High Reliability
- "Green" Device (Notes 2 and 3)

### **Mechanical Data**

- Case: SOT323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 5. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Weight: 0.006 grams (approximate)

Top View

Internal Schematic

Top View

SOT323

### Ordering Information (Notes 3 & 4)

Part Number	Qualification	Case	Packaging
BAV99W-7-F	Commercial	SOT323	3000/Tape & Reel
BAV99WQ-7-F	Automotive	SOT323	3000/Tape & Reel

Notes: 1. No purposefully added lead.

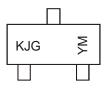
2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.

3. Product manufactured with Date Code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date

Code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

4. For packaging details, go to our website at http://www.diodes.com.

## **Marking Information**



KJG = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011) M = Month (ex: 9 = September)

#### Date Code Key

Year	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015	2016	2017
Code	S	Т	U	V	W	Х	Y	Z	А	В	С	D	E
Month	Jan	Feb	Mar	Apr	Ма	y J	un	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5		6	7	8	9	0	Ν	D



# **Maximum Ratings** $@T_A = 25$ °C unless otherwise specified

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		V <sub>RM</sub>	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	75	V
RMS Reverse Voltage		V <sub>R(RMS)</sub>	53	V
Forward Continuous Current (Note 5)		I <sub>FM</sub>	300	mA
Average Rectified Output Current (Note 5)		lo	150	mA
Non-Repetitive Peak Forward Surge Current (Note 5)	@ t = 1.0μs @ t = 1.0s	I <sub>FSM</sub>	2.0 1.0	A

# **Thermal Characteristics**

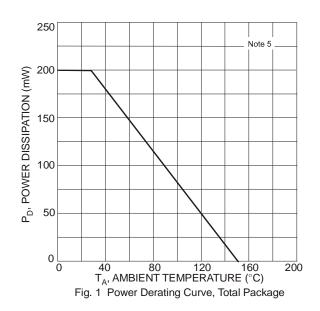
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	200	mW
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{\theta JA}$	625	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

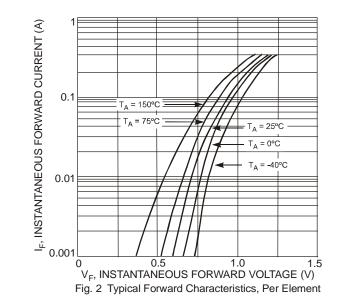
# **Electrical Characteristics** $@T_A = 25$ °C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition	
Reverse Breakdown Voltage (Note 6)	V <sub>(BR)R</sub>	75	—	V	I <sub>R</sub> = 2.5μA	
		0.55	0.70	v	I <sub>F</sub> = 1.0mA	
Forward Voltage	\/-		0.855		$I_F = 10 \text{mA}$	
Forward voltage	VF		1.0		$I_F = 50 \text{mA}$	
			1.25		I <sub>F</sub> = 150mA	
			2.5	μA	V <sub>R</sub> = 75V	
Deverse Current (Note 6)			50	μA	V <sub>R</sub> = 75V, T <sub>J</sub> = 150°C	
Reverse Current (Note 6)	I <sub>R</sub>		30	μA	V <sub>R</sub> = 25V, T <sub>J</sub> = 150°C	
			25	nA	$V_R = 20V$	
Total Capacitance	CT		2.0	pF	V <sub>R</sub> = 0, f = 1.0MHz	
			4.0	ns	$I_F = I_R = 10 \text{mA},$	
Reverse Recovery Time	t <sub>rr</sub>		4.0	115	$I_{rr} = 0.1 \text{ x } I_R, R_L = 100\Omega$	

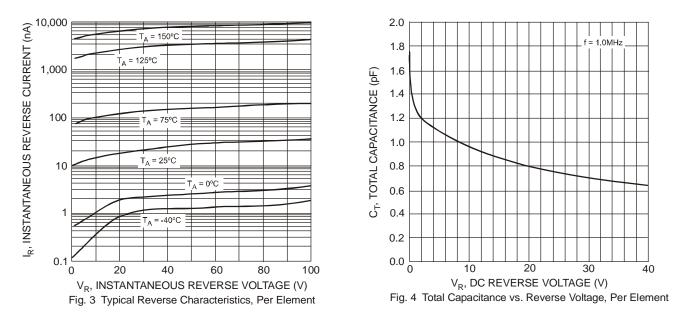
Notes:

5. Device mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com.
6. Short duration pulse test used to minimize self-heating effect.

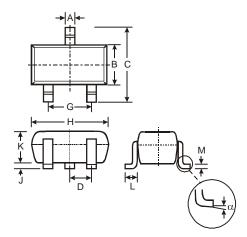






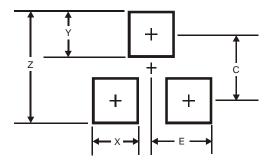


# **Package Outline Dimensions**



SOT323						
Dim	Min	Max	Тур			
Α	0.25	0.40	0.30			
В	1.15	1.35	1.30			
С	2.00	2.20	2.10			
D	-	-	0.65			
G	1.20	1.40	1.30			
Н	1.80	2.20	2.15			
J	0.0	0.10	0.05			
κ	0.90	1.00	1.00			
L	0.25	0.40	0.30			
М	0.10	0.18	0.11			
α	0°	8°	-			
All	All Dimensions in mm					

# **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	2.8
Х	0.7
Y	0.9
С	1.9
E	1.0



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